
4AK15

Silicon N-Channel Power MOS FET Array

HITACHI

Application

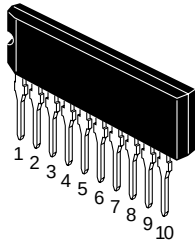
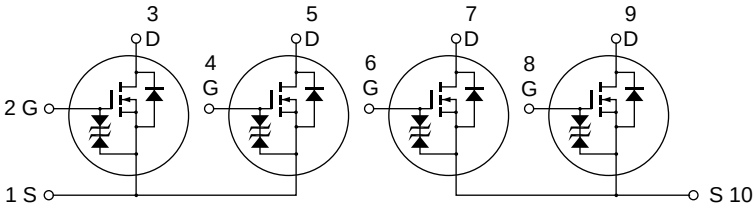
High speed power switching

Features

- Low on-resistance
 $R_{DS(on)} \leq 0.07$, $V_{GS} = 10$ V, $I_D = 8$ A
 $R_{DS(on)} \leq 0.095$, $V_{GS} = 4$ V, $I_D = 8$ A
- Capable of 4 V gate drive
- Low drive current
- High speed switching
- High density mounting
- Suitable for motor driver, solenoid driver and lamp driver

Outline

SP-10



1, 10. Source
2, 4, 6, 8. Gate
3, 5, 7, 9. Drain

Absolute Maximum Ratings (Ta = 25°C) (1 Unit)

Item	Symbol	Rating	Unit
Drain to source voltage	V_{DSS}	±60	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	8	A
Drain peak current	$I_{D(pulse)}^{*1}$	32	A
Body to drain diode reverse drain current	I_{DR}	8	A
Channel dissipation	$P_{ch} (T_c = 25^{\circ}C)^{*2}$	28	W
Channel dissipation	P_{ch}^{*2}	4	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

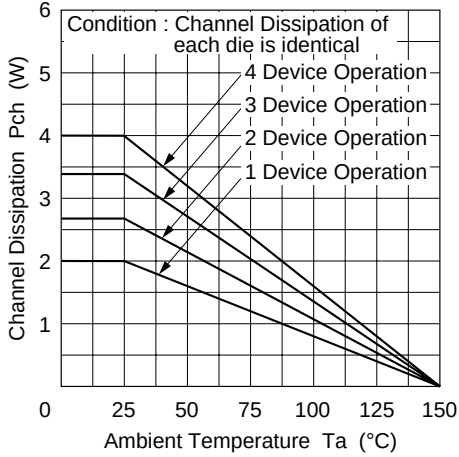
Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$
2. 4 devices operation

Electrical Characteristics (Ta = 25°C) (1 Unit)

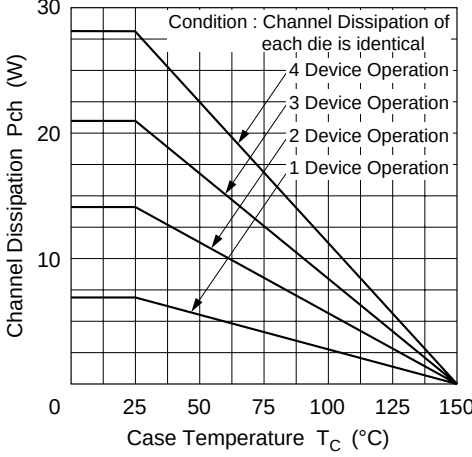
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20	—	—	V	$I_G = \pm 100 \text{ }\mu\text{A}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 16 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	250	μA	$V_{DS} = 50 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.0	V	$I_D = 1 \text{ mA}$, $V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.055	0.07	Ω	$I_D = 8 \text{ A}$ $V_{GS} = 10 \text{ V}^{*1}$
		—	0.075	0.095	Ω	$I_D = 8 \text{ A}$ $V_{GS} = 4 \text{ V}^{*1}$
Forward transfer admittance	$ y_{fs} $	7	12	—	S	$I_D = 8 \text{ A}$ $V_{DS} = 10 \text{ V}^{*1}$
Input capacitance	C_{iss}	—	860	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	450	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	140	—	pF	$f = 1 \text{ MHz}$
Turn-on delay time	$t_{d(on)}$	—	10	—	ns	$I_D = 8 \text{ A}$
Rise time	t_r	—	70	—	ns	$V_{GS} = 10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	180	—	ns	$R_L = 3.75 \text{ }\Omega$
Fall time	t_f	—	120	—	ns	
Body to drain diode forward voltage	V_{DF}	—	1.05	—	V	$I_F = 8 \text{ A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	110	—	ns	$I_F = 8 \text{ A}$, $V_{GS} = 0$ $dI_F/dt = 50 \text{ A}/\mu\text{s}$

Note: 1. Pulse test

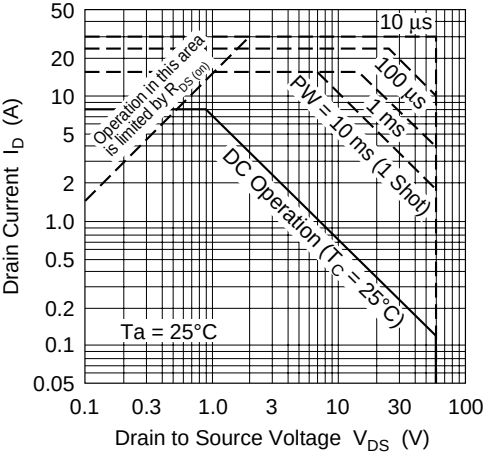
Maximum Channel Dissipation Curve



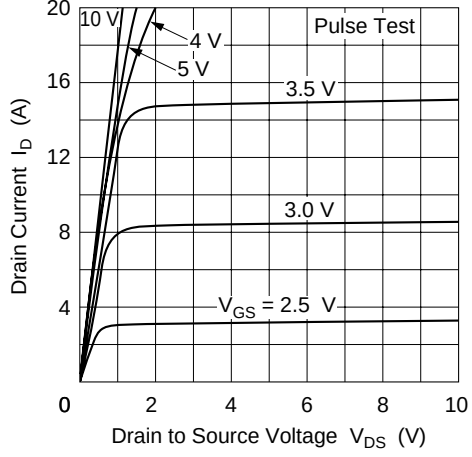
Maximum Channel Dissipation Curve



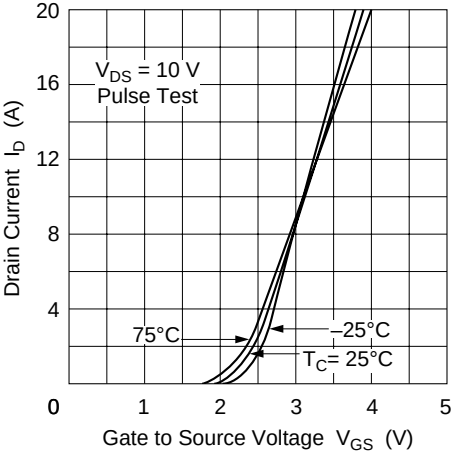
Maximum Safe Operation Area



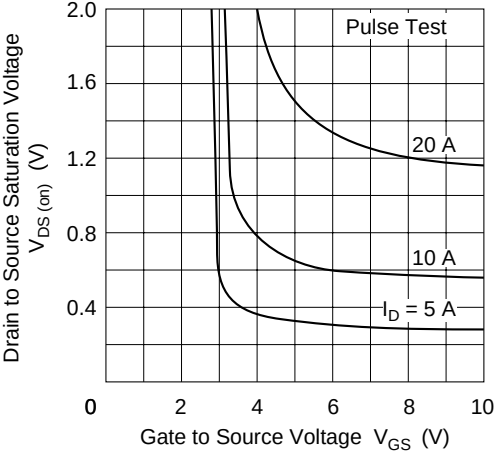
Typical Output Characteristics



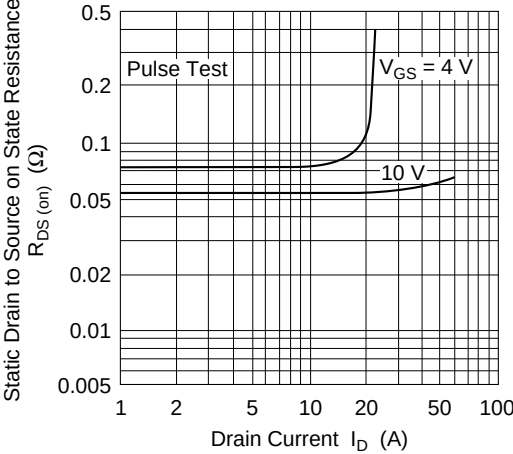
Typical Transfer Characteristics



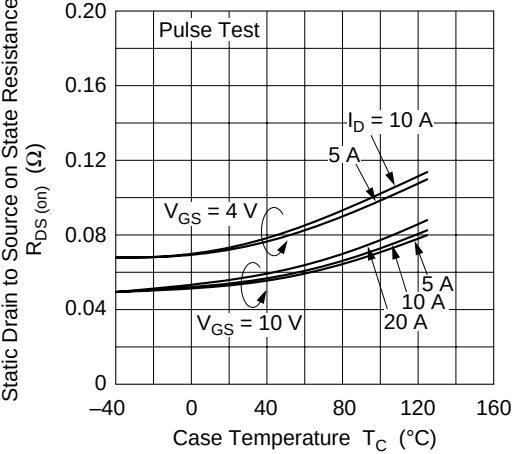
Drain to Source Saturation Voltage vs. Gate to Source Voltage



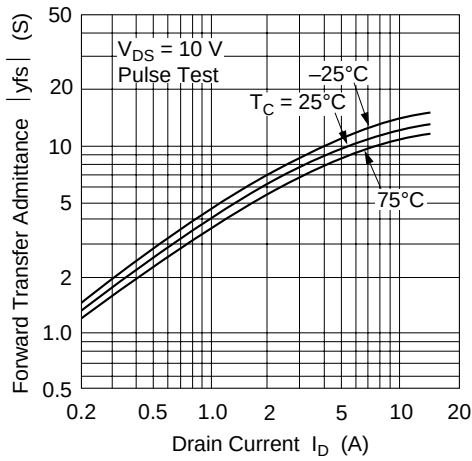
Static Drain to Source on State Resistance vs. Drain Current



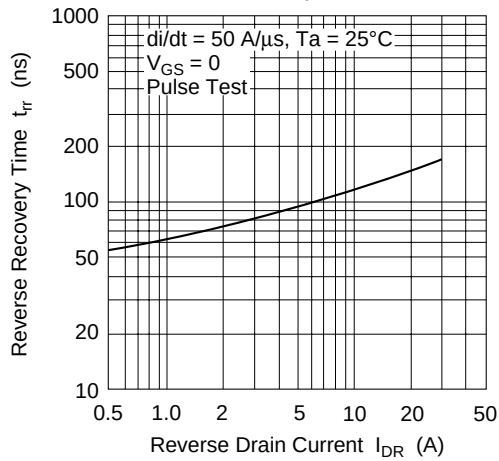
Static Drain to Source on State Resistance vs. Temperature



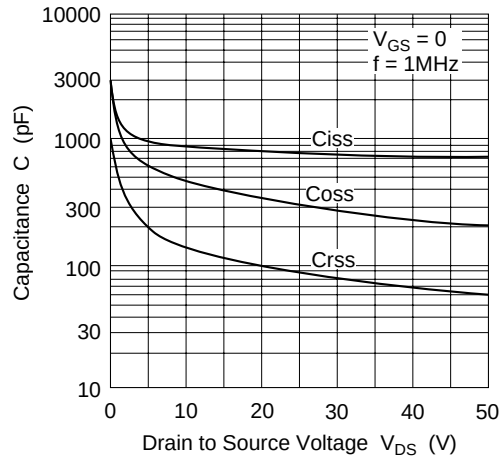
Forward Transfer Admittance
vs. Drain Current



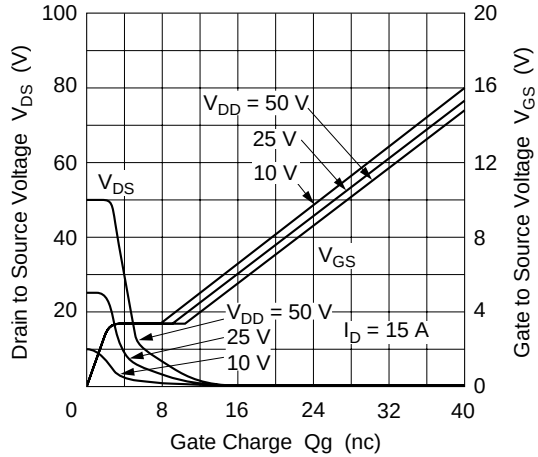
Body to Drain Diode Reverse
Recovery Time

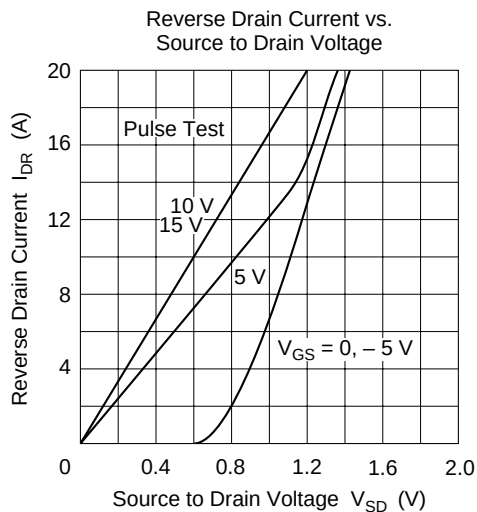
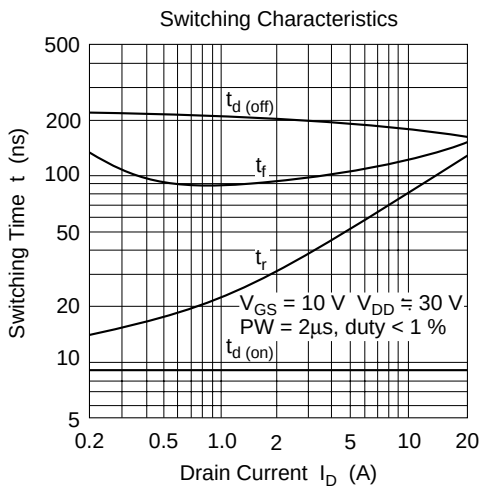


Typical Capacitance vs.
Drain to Source Voltage



Dynamic Input Characteristics





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